

Absolute Maximum Ratings		Values	Units
Symbol	Conditions ¹⁾		
V_{CES}		1200	V
V_{CGR}	$R_{GE} = 20 \text{ k}\Omega$	1200	V
I_C	$T_{case} = 25/80 \text{ }^\circ\text{C}$	100 / 80	A
I_{CM}	$T_{case} = 25/80 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	200 / 160	A
V_{GES}		± 20	V
P_{tot}	per IGBT, $T_{case} = 25 \text{ }^\circ\text{C}$	690	W
$T_j, (T_{stg})$		-40 ... + 150 (125)	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V
humidity	IEC 60721-3-3	class 3K7/IE32	
climate	IEC 68 T.1	40/125/56	
Inverse Diode			
$I_F = -I_C$	$T_{case} = 25/80 \text{ }^\circ\text{C}$	95 / 65	A
$I_{FM} = -I_{CM}$	$T_{case} = 25/80 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	200 / 160	A
I_{FSM}	$t_p = 10 \text{ ms}; \text{sin.}; T_j = 150 \text{ }^\circ\text{C}$	720	A
I^2t	$t_p = 10 \text{ ms}; T_j = 150 \text{ }^\circ\text{C}$	2600	A^2s

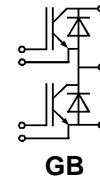
Characteristics		min.	typ.	max.	Units
Symbol	Conditions ¹⁾				
$V_{(BR)CES}$	$V_{GE} = 0, I_C = 4 \text{ mA}$	$\geq V_{CES}$			V
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 2 \text{ mA}$	4,5	5,5	6,5	V
I_{CES}	$V_{GE} = 0 \left. \begin{array}{l} T_j = 25 \text{ }^\circ\text{C} \\ V_{CE} = V_{CES} \end{array} \right\} T_j = 125 \text{ }^\circ\text{C}$		0,1	1,5	mA
I_{GES}	$V_{GE} = 20 \text{ V}, V_{CE} = 0$			300	nA
V_{CESat}	$I_C = 75 \text{ A} \left. \begin{array}{l} V_{GE} = 15 \text{ V}; \\ T_j = 25 \text{ }^\circ\text{C} \end{array} \right\}$		3,3	3,65	V
V_{CESat}	$I_C = 100 \text{ A} \left. \begin{array}{l} V_{GE} = 15 \text{ V}; \\ T_j = 25 \text{ }^\circ\text{C} \end{array} \right\}$		3,8		V
g_{fs}	$V_{CE} = 20 \text{ V}, I_C = 75 \text{ A}$	31			S
C_{CHC}	per IGBT			350	pF
C_{ies}	$V_{GE} = 0$		5	6,6	nF
C_{oes}	$V_{CE} = 25 \text{ V}$		720	900	pF
C_{res}	$f = 1 \text{ MHz}$		380	500	pF
L_{CE}				25	nH
$t_{d(on)}$	$V_{CC} = 600 \text{ V}$		80		ns
t_r	$V_{GE} = -15 \text{ V} / +15 \text{ V}^{3)}$		40		ns
$t_{d(off)}$	$I_C = 75 \text{ A, ind. load}$		360		ns
t_f	$R_{Gon} = R_{Goff} = 8 \text{ }^\circ\Omega$		20		ns
E_{on}	$T_j = 125 \text{ }^\circ\text{C}$		9		mWs
E_{off}			3,5		mWs
Inverse Diode ⁸⁾					
$V_F = V_{EC}$	$I_F = 75 \text{ A} \left. \begin{array}{l} V_{GE} = 0 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$		2,0(1,8)	2,5	V
$V_F = V_{EC}$	$I_F = 100 \text{ A} \left. \begin{array}{l} V_{GE} = 0 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$		2,25(2,05)		V
V_{TO}	$T_j = 125 \text{ }^\circ\text{C}$			1,2	V
r_t	$T_j = 125 \text{ }^\circ\text{C}$		12	15	$\text{m}\Omega$
I_{RRM}	$I_F = 75 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}^{2)}$		27(40)		A
Q_{rr}	$I_F = 75 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}^{2)}$		3(10)		μC
Thermal characteristics					
R_{thjc}	per IGBT			0,18	$^\circ\text{C}/\text{W}$
R_{thjc}	per diode			0,50	$^\circ\text{C}/\text{W}$
R_{thch}	per module			0,05	$^\circ\text{C}/\text{W}$

SEMITRANS® M Ultra Fast IGBT Modules

SKM 100 GB 125 DN



SEMITRANS 2N (low inductance)



Features

- N channel, homogeneous Si
- Low inductance case
- **Short tail** current with low temperature dependence
- High short circuit capability, self limiting to $6 \cdot I_{cnom}$
- Fast & soft inverse CAL diodes ⁸⁾
- Isolated copper baseplate using DCB Direct Copper Bonding Technology
- Large clearance (10 mm) and creepage distances (20 mm)

Typical Applications

- Switched mode power supplies at $f_{sw} > 20 \text{ kHz}$
- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at $f_{sw} > 20 \text{ kHz}$

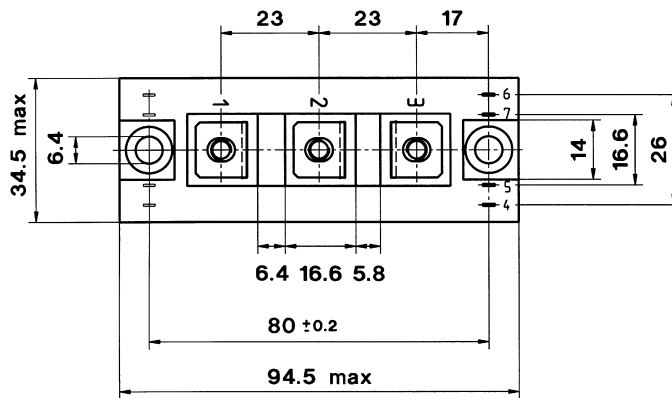
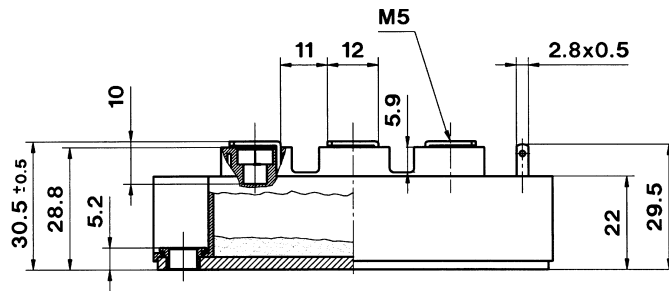
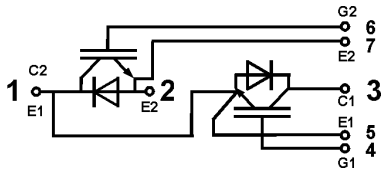
¹⁾ $T_{case} = 25 \text{ }^\circ\text{C}$, unless otherwise specified
²⁾ $I_F = -I_C, V_R = 600 \text{ V}, -di_F/dt = 800 \text{ A}/\mu\text{s}, V_{GE} = 0 \text{ V}$
³⁾ Use $V_{GEoff} = -5 \dots -15 \text{ V}$
⁸⁾ CAL = Controlled Axial Lifetime Technology

SEMITRANS 2N (low inductance)

Case D 93
 UL Recognized
 File no. E 63 532

CASED93

SKM 100 GB 125 DN



Dimensions in mm

Case outline and circuit diagram

Mechanical Data			Values			Units
Symbol	Conditions		min.	typ.	max.	
M ₁	to heatsink, SI Units to heatsink, US Units	(M6)	3	—	5	Nm lb.in.
M ₂	for terminals, SI Units for terminals, US Units	(M5)	2,5	—	5	Nm lb.in.
a			—	—	5x9,81	m/s ²
w			—	—	160	g

This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.

Eight devices are supplied in one SEMIBOX A without mounting hardware, which can be ordered separately under Ident No. 33321100 (for 10 SEMITRANS 2)

Larger packing units of 20 and 42 pieces are used if suitable

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.